



SPECIFICATION FOR APPROVAL

.....

CUSTOMER			
NOMINAL FREQUENCY	25.000000 MHz		
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL		
SPEC. NO. (P/N)	FL2500316Q		
CUSTOMER P/N			
ISSUE DATE	November 18, 2017		
VERSION	В		

APPROVED	PREPARED	QA	
Brenda	Clane	Dong Jang	

Diodes Incorporated

No.2, Ziqiang 5th Rd., Zhongli Industrial Park, Zhongli Dist., Taoyuan City 32063, Taiwan (R.O.C.)

TEL: 886-3-451-8888 FAX: 886-3-461-3865 https://www.diodes.com

- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant
- *AEC-Q200 Compliant

E0-R-4-014 Rev. F

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL FL2500316Q

VER. B 18-Nov-17

VERSION HISTORY

Version No.	Version Date	Description	Notes
А	Jul.28,2017	Initial Release	
В	Nov.18,2017	Updated logo	



E0-R-4-014 Rev. F

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL FL2500316Q VER. B 18-Nov-17

ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	25.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	20	pF	
Calibration Tolerance	FL	±20	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +100	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±20	ppm	Reference to the Frequency at 25°C
Operating Drive Level		300	μW	
Maximum Drive Level		300	μW	
Equivalent Series Resistance	ESR	30	Ω	Max
Shunt Capacitance	C0	7	pF	Max
Trim Sensitivity	TS	10	ppm/pF	Max
Q-Factor	Q	30000		Min
3rd Harmonic Motional Resistance		30	Ω	Min
Aging at 25°C		±20	ppm	Max, 10 years
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	МΩ	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



E0-R-4-014 Rev. F Page 1

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

FL2500316Q

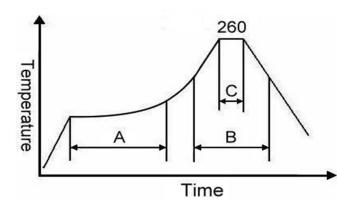
VER. B 18-Nov-17

AEC-Q200 RELIABILITY TEST SPECIFICATIONS:

- 1. Initial
- 1.1 Physical Dimensions: JESD22, Method JB1-100
- 1.2 External Visual: MIL-STD-883, Method 2009
- 1.3 Freq. Vs. Temperature: Per Specification/Datasheet
- 2. Mechanical
- 2.1 Mechanical Shock: MIL-STD-202 Method 213
- 2.2 Vibration: MIL-STD-202 Method 204
- 2.3 Solderability: J-STD-002
- 2.4 Board Flex: AEC Q200-005
- 2.5 Terminal Strength (SMD): AEC Q200-006
- 3.Environmental
- 3.1 Temp Cycle: JESD22, Method JA-104
- 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210
- 3.3 High Temperature Operating Life: MIL-STD-202, Method 108
- 3.4 High Temp Exposure: MIL-STD-202, Method 108
- 3.5 High Temp & High Humidity: MIL-STD-202, Method 103
- 3.6 Thermal Shock: MIL-STD-202, Method 107

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



N	^	٠	•	•
	v	L	c	

	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

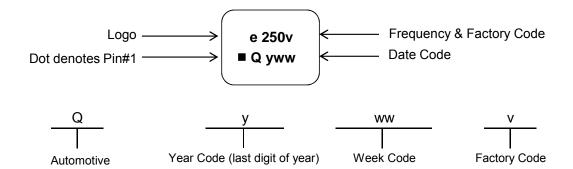
E0-R-4-014 Rev. F

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

FL2500316Q

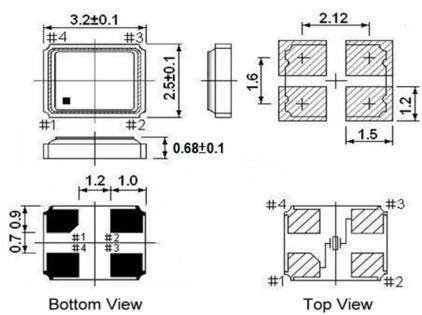
VER. B 18-Nov-17

MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.



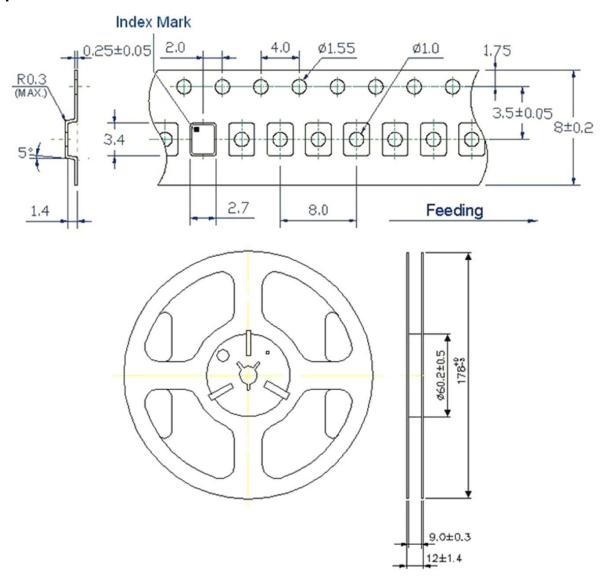
E0-R-4-014 Rev. F Page 3

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

FL2500316Q

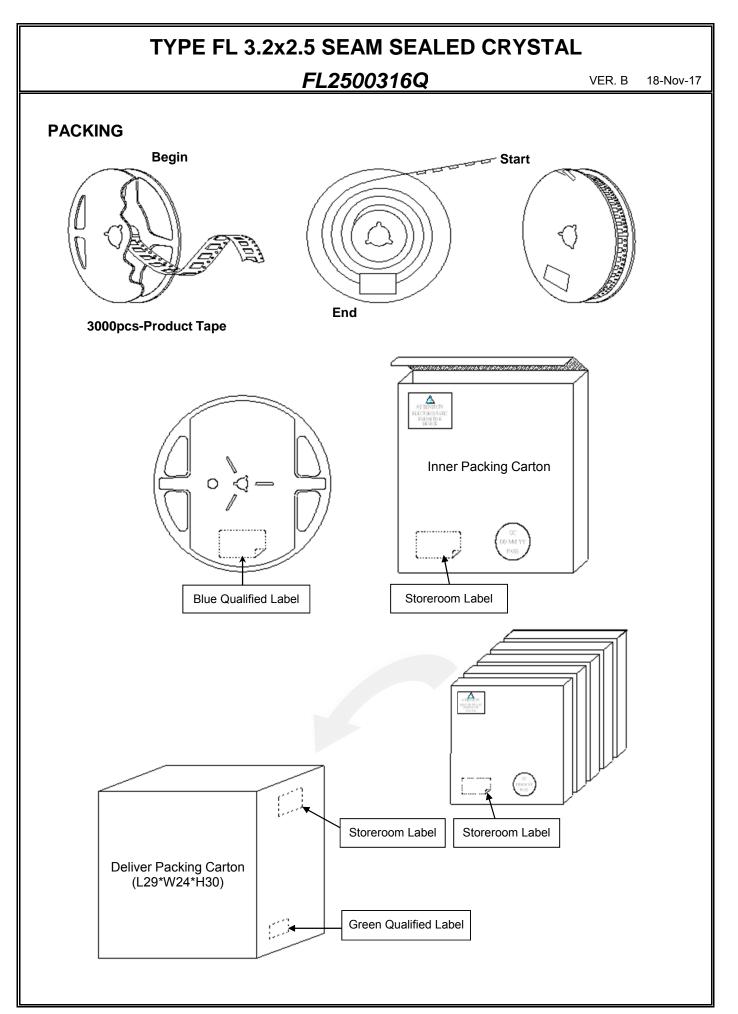
VER. B 18-Nov-17

Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

E0-R-4-014 Rev. F Page 4





E0-R-4-014 Rev. F Page 5